## COMPARISON OF UV AND EB PROCESSING ON STRUCTURE PROPERTY RELATIONSHIPS

SAEID BIRIA PHD & JON SCHOLTE PHD

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## SIMILAR BUT NOT THE SAME





UV allows for easier controls of processing parameters
EB has higher energy and can alter polymerization mechanism and processing



## **RADIATION CURE BENEFITS**



- Green technology
- No solvent waste
- Low hazard

## Very low VOC emissions



- Process efficiency and flexibility
- Room-temperature curing
- Low heat generation
- Simple adaptation to existing lines
- Ease of cleaning
- 10 times less space utilization than a conventional drying oven

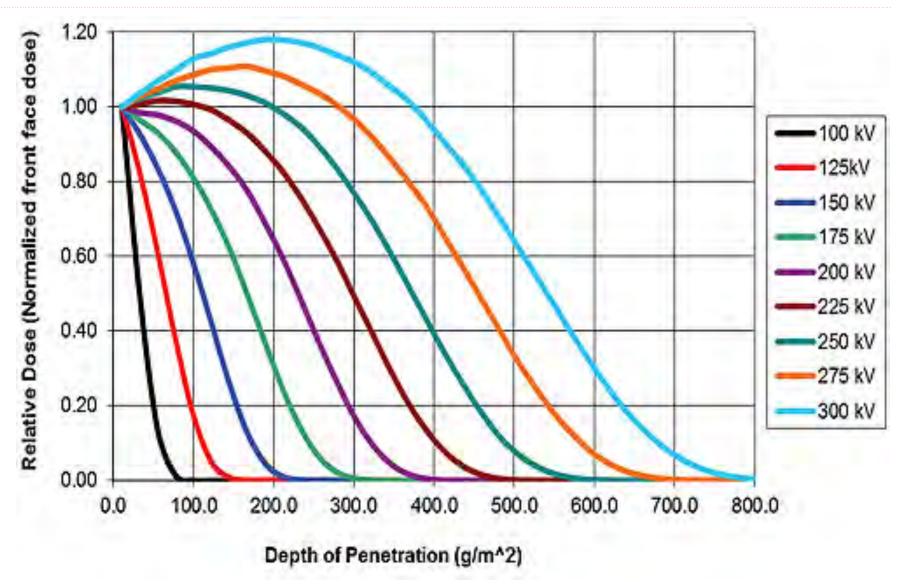


- High productivity and cost savings
- Reduced cycle time
- Increased throughput
- Instant on/off
- Low energy consumption
- No solvent waste recycling
- Minor maintenance cost

4 times less energy consumption than thermal curing



### DEPTH / DOSE CURVES



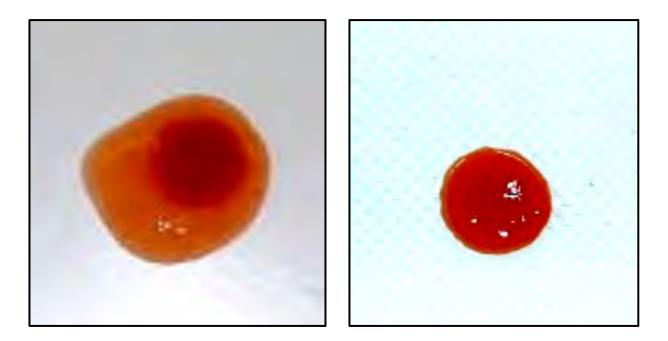


### EFFECTIVE ELECTRON PENETRATION AT HIGH VOLTAGES

High Voltage kV	Depth Mils	Depth Gm/M <sup>2</sup>
90	0.8	20.0
110	1.2	30.0
125	1.8	45.0
150	3.5	90.0
175	5.0	125.0
200	7.0	175.0
250	11.0	275.0
300	16.0	400.0



#### EB: IMPROVED DOT GAIN CONTROL



Conventional Ink Dot Gain EB Ink Dot Gain



Energy loss events along the trajectory of a charged particle ( "string of beads")

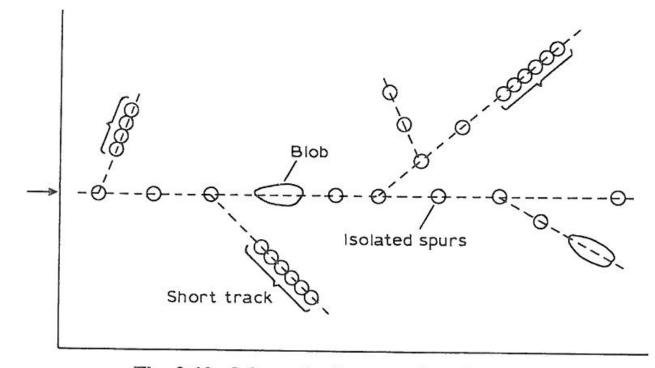


Fig. 9.12. Schematic diagram of track entities.

Energy deposited:

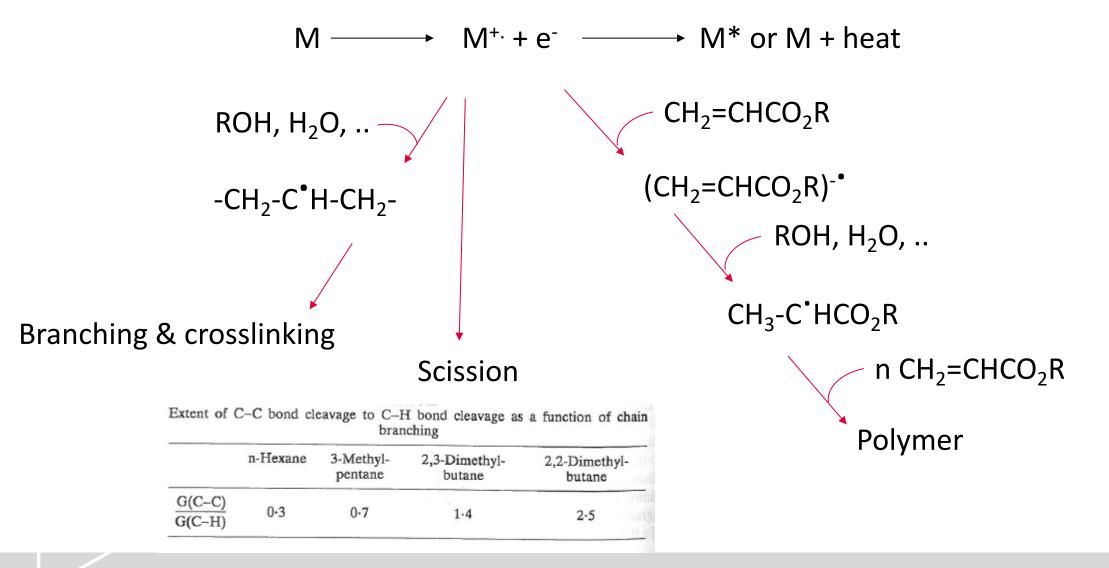
- « spurs » < 100 eV</li>
- « Blobs » 100 to 500 eV
- «Tracks » 500 to 5000 eV

Bond 🔶	Bond +	Bond-dissociation energy at 298 K		
Bond ÷	Bond <del>\$</del>	(kcal/mol) ¢	(kJ/mol) ¢	(eV/Bond) +
H <sub>3</sub> C–H	Methyl C-H bond	105	439	4.550
C <sub>2</sub> H <sub>5</sub> –H	Ethyl C-H bond	101	423	4.384
(CH <sub>3</sub> ) <sub>2</sub> CH–H	Isopropyl C-H bond	99	414	4.293
(CH <sub>3</sub> ) <sub>3</sub> C–H	t-Butyl C-H bond	96.5	404	4.187
(CH <sub>3</sub> ) <sub>2</sub> NCH <sub>2</sub> -H	C–H bond α to amine	91	381	3.949
(CH <sub>2</sub> ) <sub>3</sub> OCH–H	C–H bond $\alpha$ to ether	92	385	3.990

Source: wikipedia



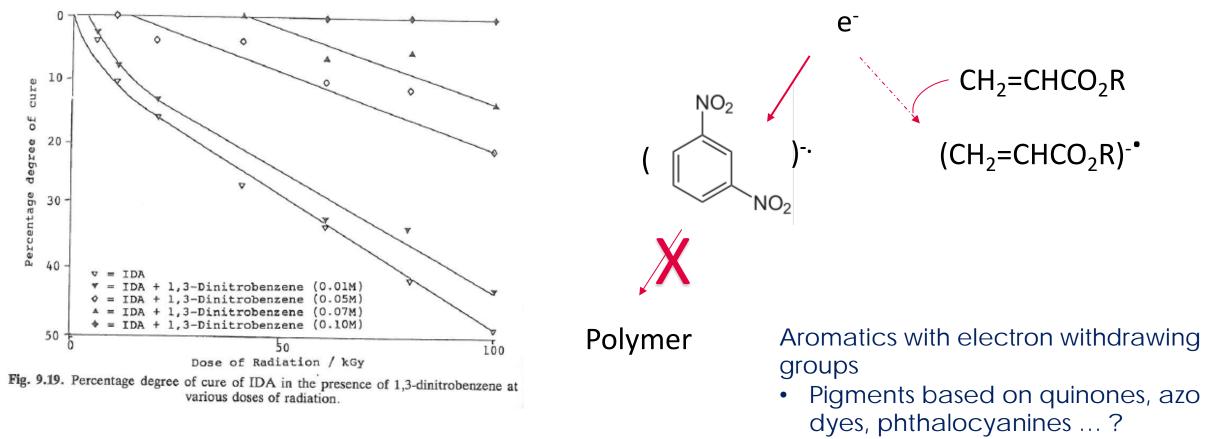
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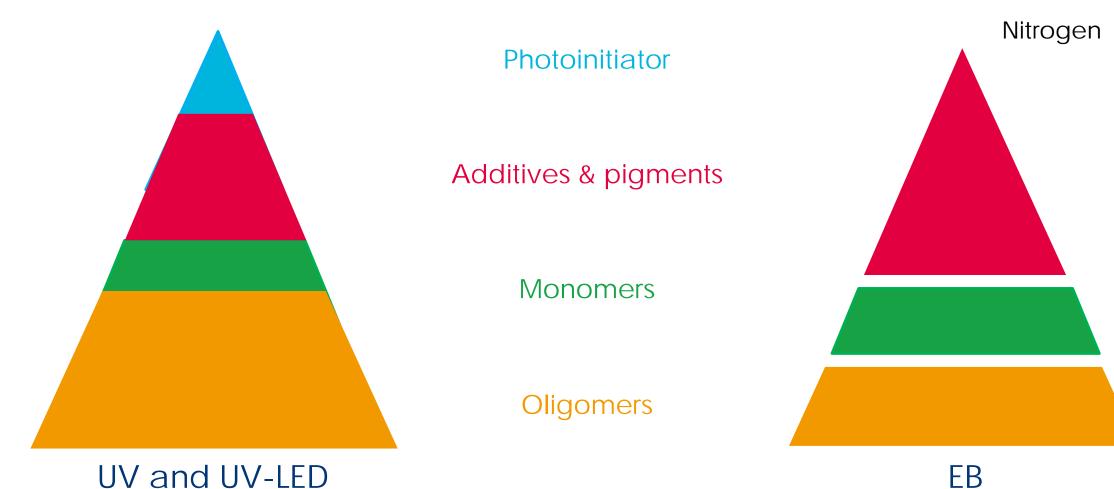
### INHIBITION / RETARDATION OF EB ACRYLATE POLYMERIZATION



- Vinyl aromatics?
- Unsaturated esters ?

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## FORMULATION FOR UV AND EB



EB

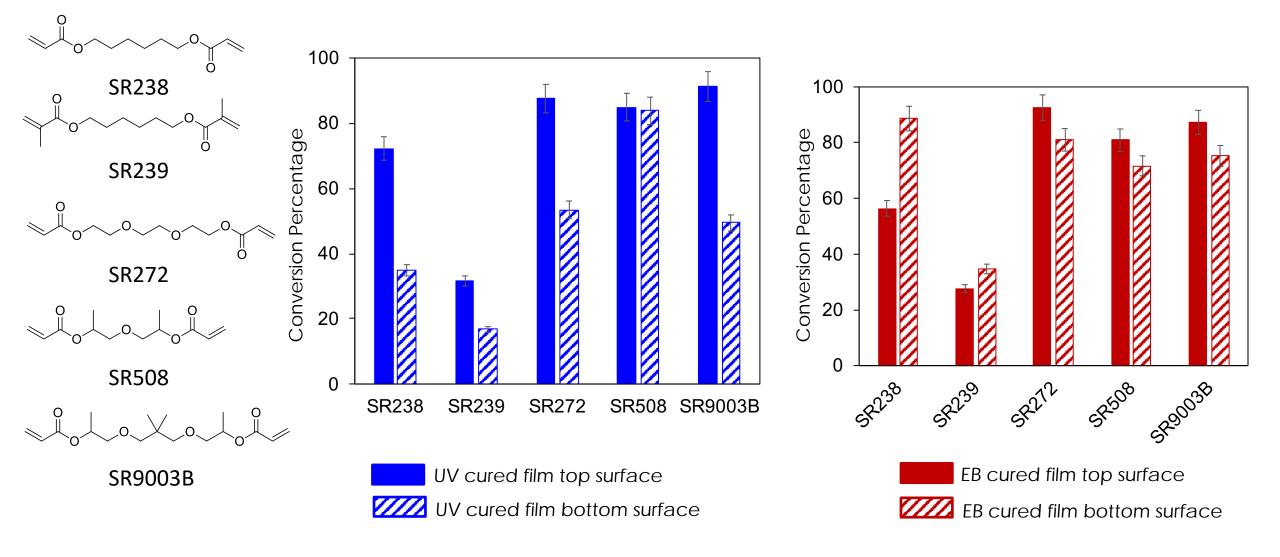




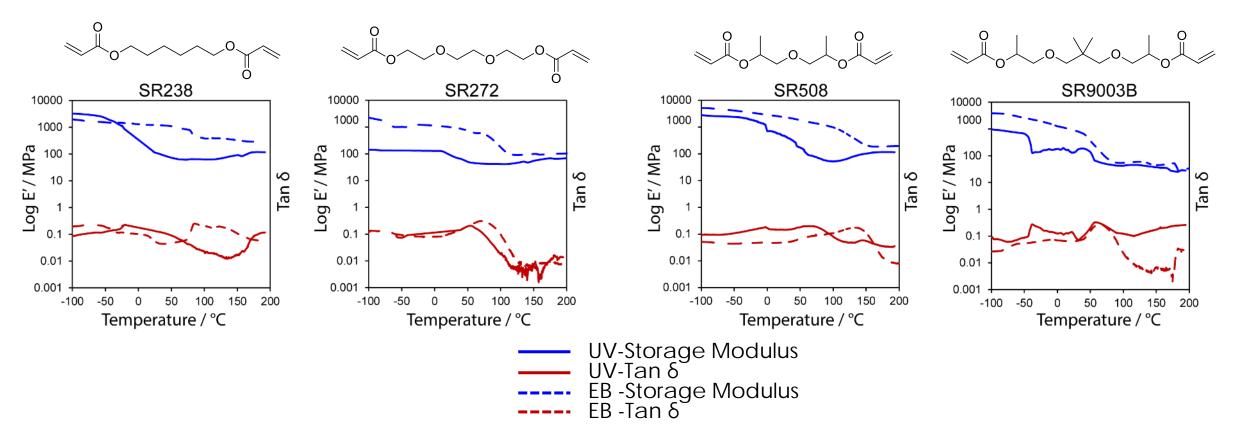
# MONOMER STUDIES



### **DIFUNCTIONAL MATERIALS - CURE**





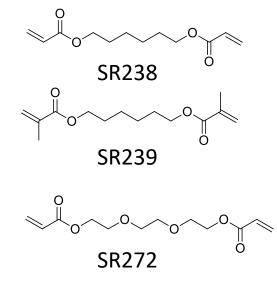


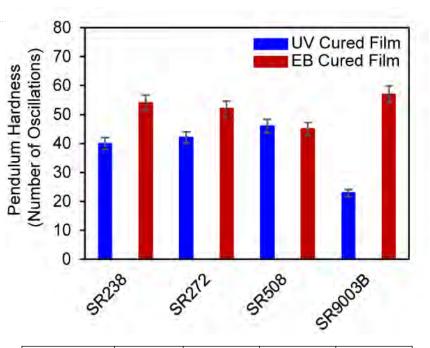
Alterations to curing mechanism through increased side reactions lead to increased modulus and T<sub>g</sub>

## DIFUNCTIONAL HARDNESS/TENSILE

Increased crosslinking from side reactions through monomer choice increases hardness







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SR508

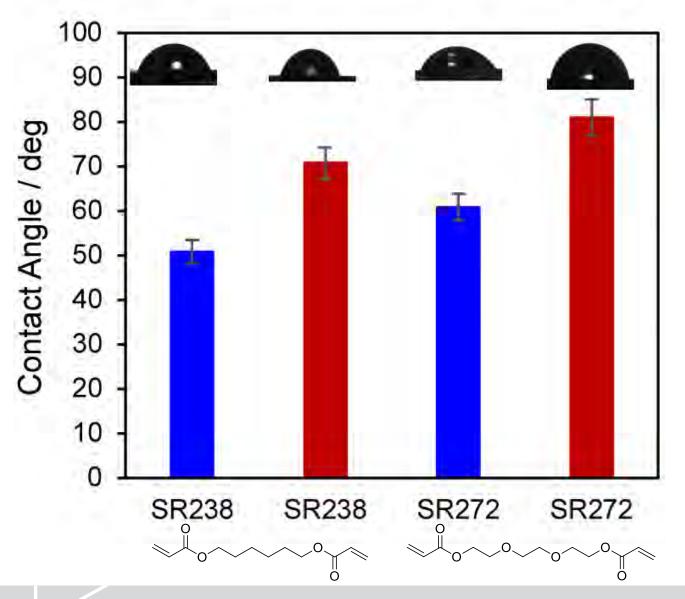


SR9003B

Composition	50 Cycles	100 Cycles	150 Cycles	200 Cycles
SR238 UV	haze	haze	haze	haze
SR238 EB	haze	haze	haze	haze
SR239 UV	*	*	*	*
SR239 EB	*	*	*	*
SR272 UV	haze	haze	haze	haze
SR272 EB	haze	haze	haze	haze
SR508 UV	haze	haze	haze	haze
SR508 EB	haze	haze	haze	haze
SR9003B UV	haze	haze	haze	haze
SR9003B EB	haze	haze	haze	haze

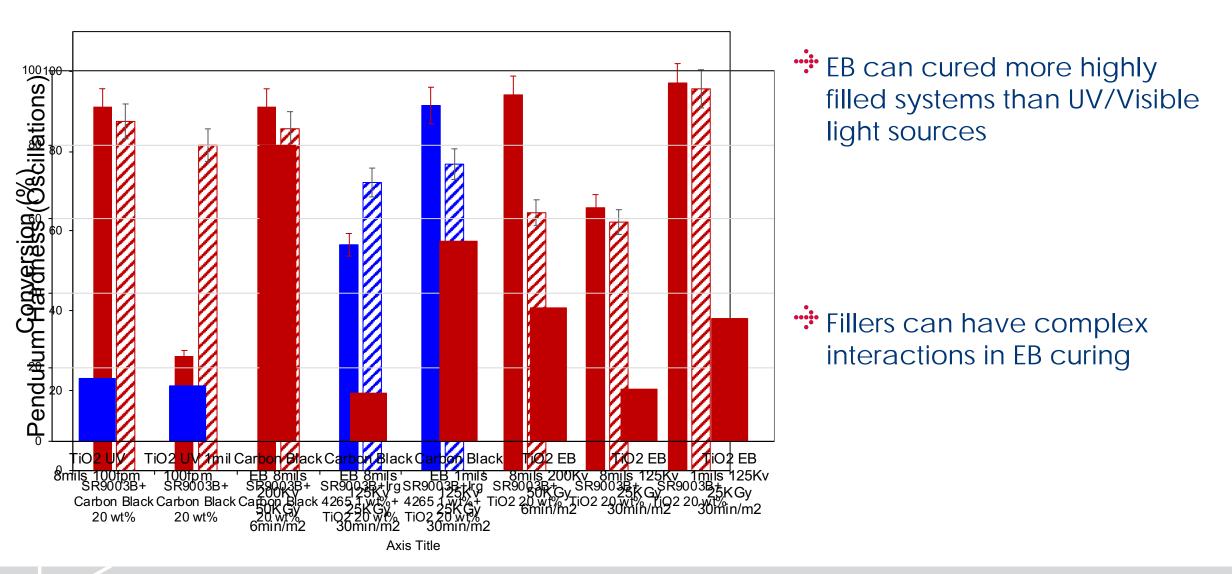


## RADIATION CURING EFFECTS ON SURFACE CHEMISTRY



Interactions between EB source and surface chemistry reacts to increase contact angle of water





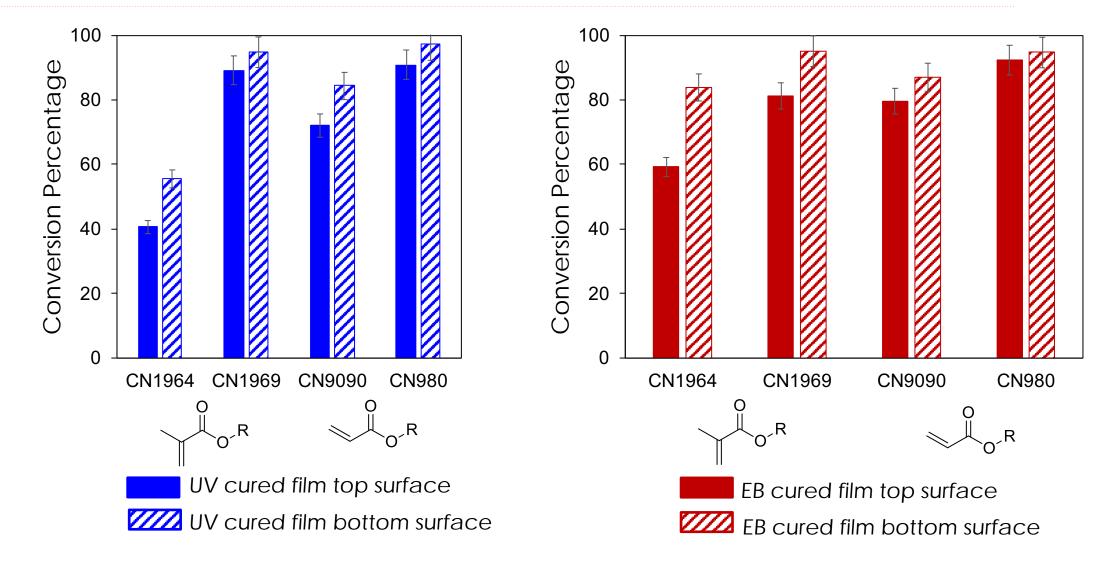




## OLIGOMER STUDIES

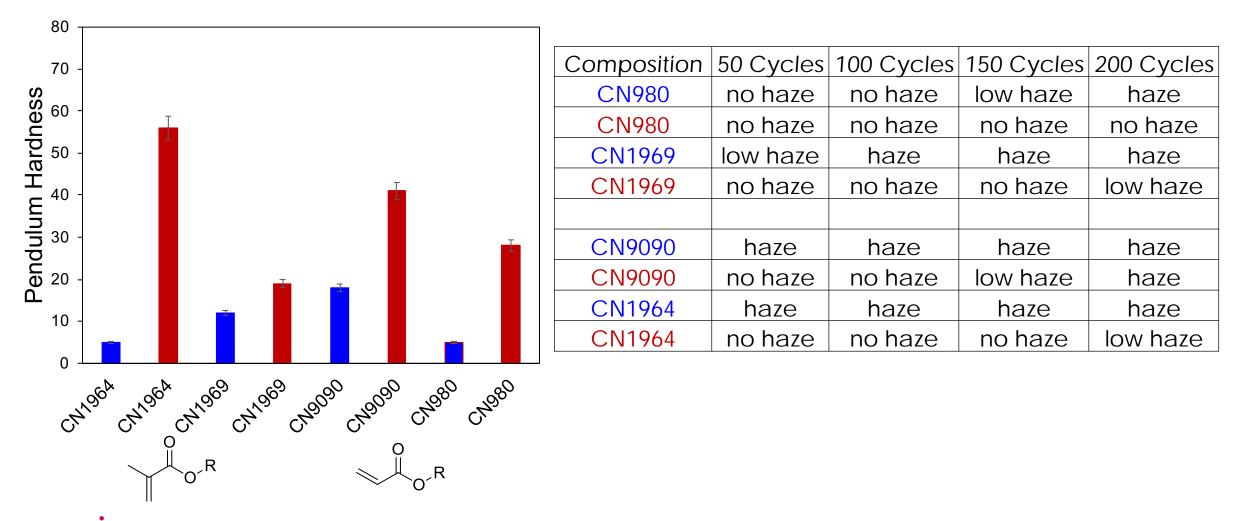


### URETHANE ACRYLATE VS URETHANE METHACRYLATE





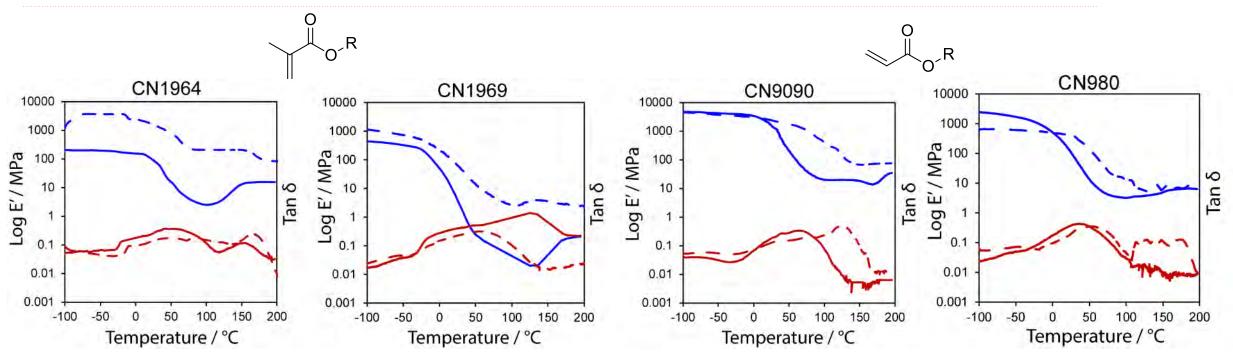
## **DIFUNCTIONAL MATERIALS-CURE**



\* Increased performance of EB materials likely due to increased crosslinking



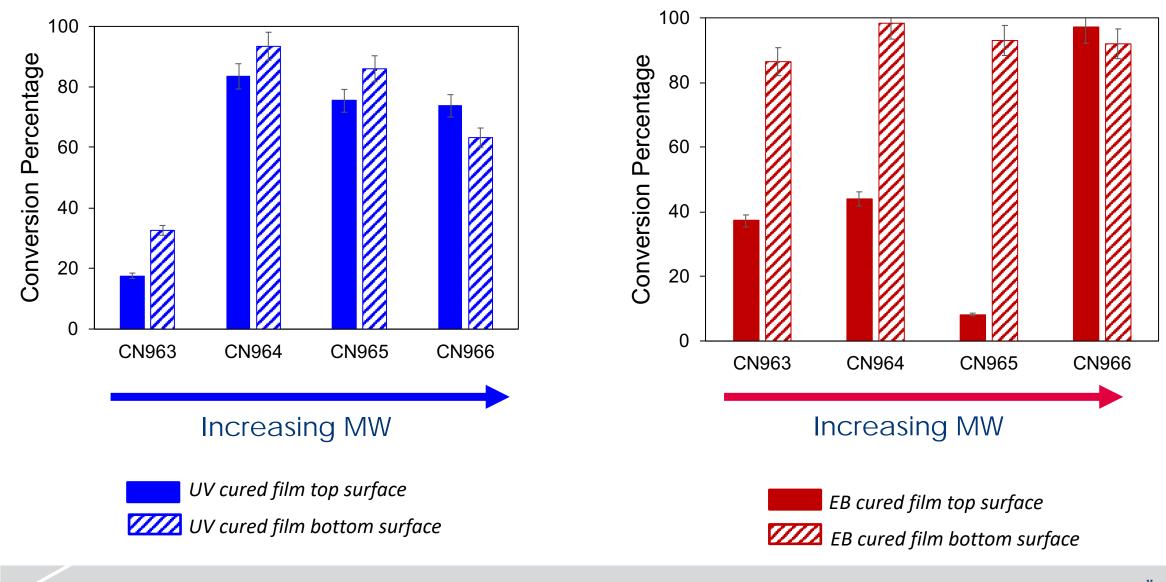
## POLYURETHANE (METH) ACRYLATE THERMOMECHANICAL STUDIES



UV Cure of methacrylate oligomers show increased storage modulus due to interactions between urethane and polyol backbone chemistry

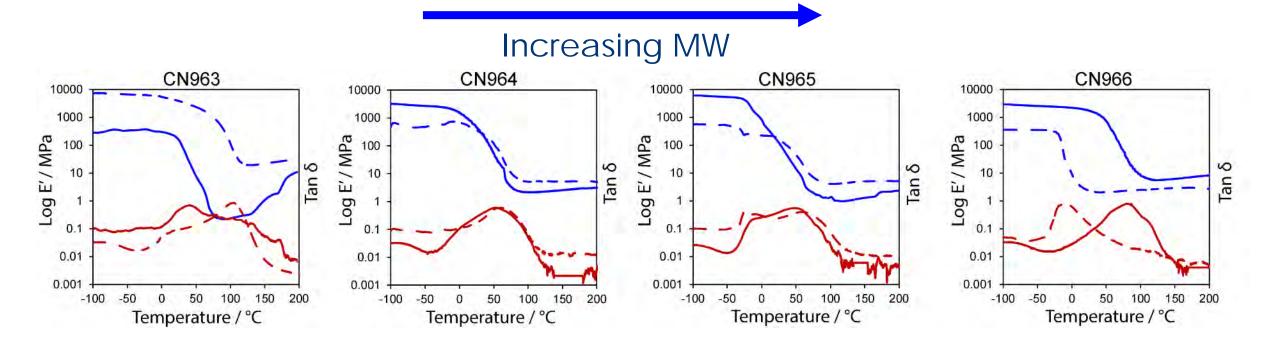
Urethane acrylates show increased T<sub>g</sub> as well as increased crosslinking

## EFFECTS OF URETHANE ACRYLATE MW ON CONVERSION





## EFFECTS OF POLYURETHANE MOLECULAR WEIGHT

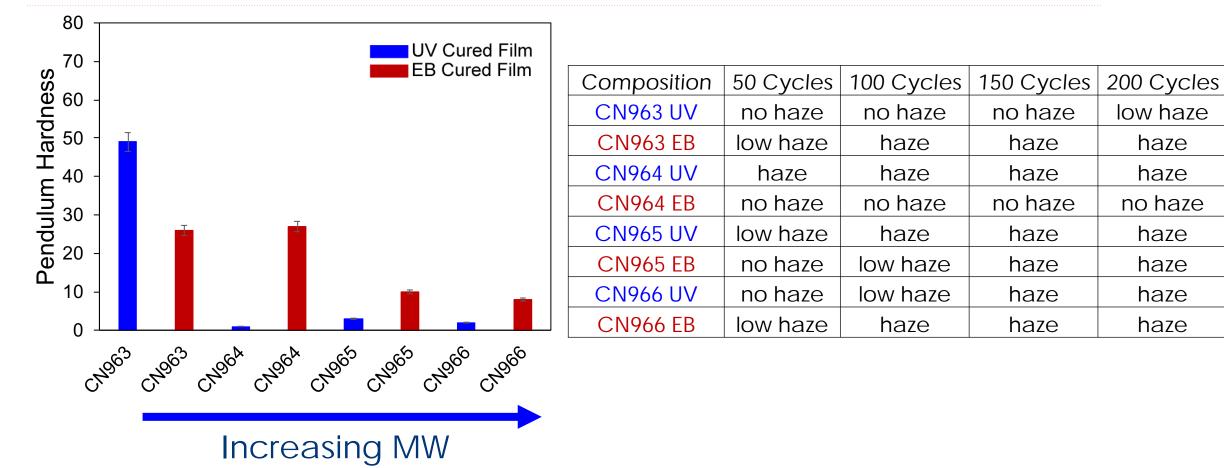


Increasing polyester content leads to interesting EB cure behavior

Increasing chain scission lowers T<sub>g</sub> and modulus



## POLYURETHANE ACRYLATE MW HARDNESS



Balancing polyester content and reactivity is necessary to maximize performance

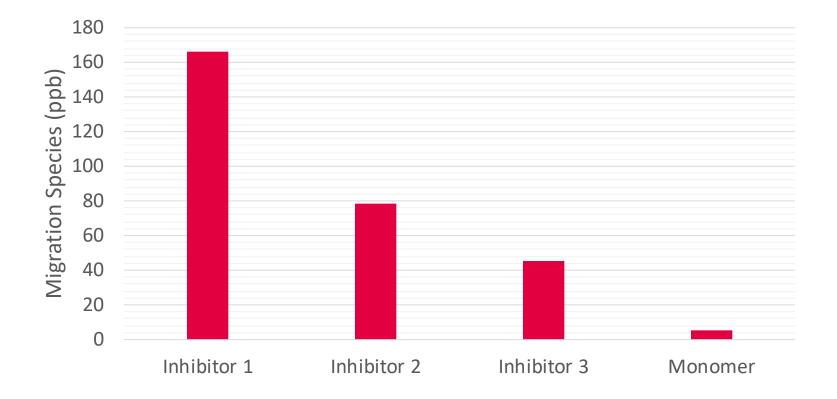


Property	UV cured	EB cured
Viscosity at 25°C (cP)	6,650	6,650
Cured PSA Thickness (mil)	2.7	2.1
Curing Method	UV (H Bulb)	EB
Energy (J/cm <sup>2</sup> )	0.49	10 Mrad/175 kV
180° Peel on Stainless Steel; 1 day (lb/in)	7.6	4.2
180° Peel on Polypropylene; 1 day (lb/in)	4.8	4.5
Probe Tack (lb)	2.26	2.06
Room Temp Shear 2 kg (hr)	34	>167
Room Temp Shear 1 kg (hr)	84	>167
SAFT ( <sup>0</sup> F)	185	435
Refractive Index	1.49	1.49

 Modifications to PSA rheology change properties to increase shear and adhesion failure temperature tests.



## MIGRATION IN EB CURABLE FILMS



- $\rightarrow$  Ongoing work to limit migratable species and formation.
- $\rightarrow$  Inhibitors selection is important to limit small molecule species
- $\rightarrow$  Single ppb or no monomers detected

## CONCLUSIONS

UV and EB processing create different polymerization methods with significantly different side reactions

- Polymer backbone and reactive groups further impact the types of side reactions
- The increased crosslinking in EB processing can lead to much lower levels of migratables in polymer films







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CONTACT US JON.SCHOLTE@SARTOMER.COM

